

SPECIFICATION

Customer: ELTECH STARLINE

		Receipt
Item:	Crystal Unit	
	Crystal Onit	—
Туре:	NX2520SA	
		—
Nominal frequency	16.000 MHz	
Customer's Spec. No.:		
		—
NDK Spec. No.:	EXS00A-CS07310	

Charge:

Sales	NDK-I P.Bandera	Tel. 39-02-96702920	Approved	H.Kobayashi
Engineer	1 st Eng. Dept. N.Wakisaka	Tel. 81-4-2900-6631	Checked	N.Yamamoto
			Drawn	N.Wakisaka

	Revision Record							
Rev.	Rev. Date	Items	Contents	Remarks				
	10.Oct.2013	Issue						

1. Customer specifications number	:
2. NDK specification number	: EXS00A-CS07310
3. Туре	: NX2520SA
 4. Electrical characteristics 4.1 Nominal frequency (F_{nom}) 4.2 Overtone order 4.3 Frequency tolerance 4.4 Frequency versus temperature characteristics 4.5 Equivalent resistance 4.6 Maximum drive level 4.7 Insulation resistance 	 16.000 MHz Fundamental (AT-cut) ±10×10⁻⁶ max. (at +25°C) ±15×10⁻⁶ max. (at -40~+85°C) The reference temperature shall be +25°C. 80Ω max. 200µW max. Terminal to terminal insulation resistance also terminal to cover insulation resistance must be 500MΩ (min) when DC100V ±15V is applied.
 5. Measurement circuit 5.1 Frequency measurement Measuring instrument Load capacitance(C_L) Level of drive 5.2 Equivalent resistance measurement Measuring instrument Load capacitance(C_L) Level of drive 	: IEC π-Network : 10pF : 10μW : IEC π-Network : Series : 10μW
6. Other performances6.1 Operating temperature range6.2 Storage temperature range6.3 Air-tightness	: -40~+85°C : -40~+85°C : Less than 1.1×10 ⁻⁹ Pa m ³ /s (Helium leak detector)
7. Examination results document Since a performance is guaranteed, an exam	nination results document does not submit.
 8. Application drawing 8.1 External dimension 8.2 Taping and reel figure 8.4 Holder marking 8.5 Reliability assurance Item 8.6 Recommendation reflow profile 	: EXD14B-00420 : EXK17B-00161 : EXH11B-00317 : EXS30B-00249 : EXS30B-00344

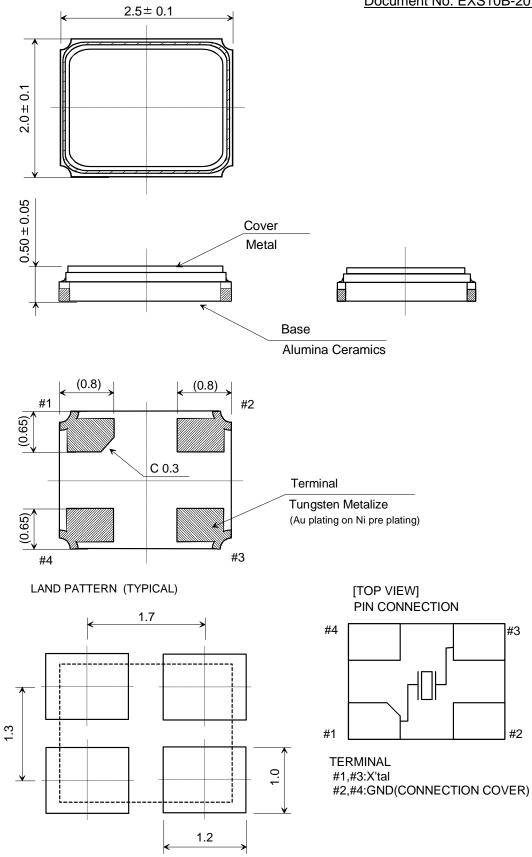
9. Notice

- 9.1 Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 9.2 Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 9.3 In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 9.4 Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.
- 9.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage. Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 9.6 If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 9.7 In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 9.8 Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 9.9 Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.

10. Prohibited items

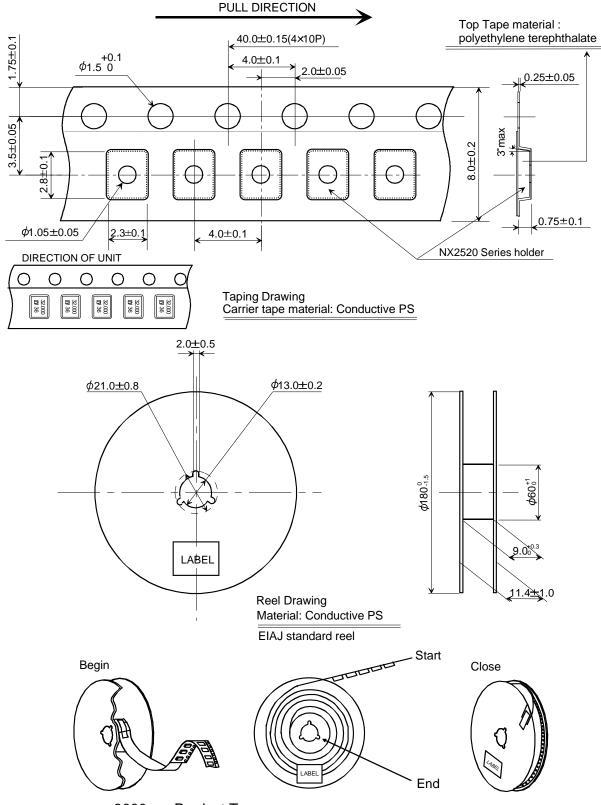
Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

- (1) Reflow soldering heat resistance Peak temperature: 265°C, 10 sec Heating: 230°C or higher, 40 sec Preheating: 150°C to 180°C, 120 sec Reflow passage times: twice
- (2) Manual soldering heat resistance Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).



Da	te of Revise	Charge	Approved	Reason			
	Date	Name	Third Angle Proje	ction	Tolerance	Sc	ale
Drawn	30.Oct.2007	K.Sato	Dimension:mr	n		- /	/ _
Designed	30.Oct.2007	K.Sato	Title		Drawing No.		Rev.
Checked			NX252	0SA		00400	
Approved	30.Oct.2007	K.Kubota	Dimension Drawing		EXD14B	-00420	

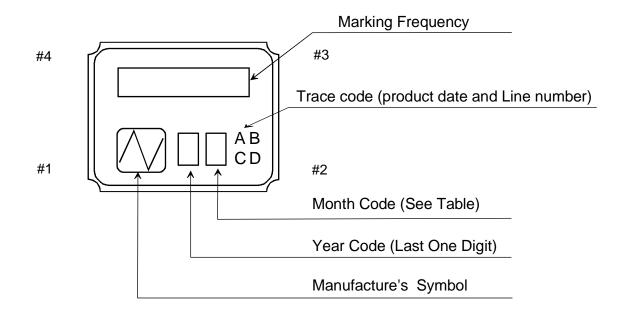
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3000pcs-Product Tape

	Dat	e of Revise	Charge	Approved	Reason					
В	14.	Mar. 2008	Wada	Kubota	Change	Changed drawing title				
		Date	Name	Third Angle Projection Tolerance		Third Angle Projection Tolerance		Third Angle Projection Tolerance		ale
Drawr	n	19.Jun.2003	H.Yagishita	Dimension: r	mm	m		- / -		
Desig	gned	19.Jun.2003	H.Yagishita	Title		Drawing No.		Rev.		
Chec	ked	19.Jun.2003	K.Kubota	NX2520	Series	EXK17B	00161	В		
Appro	oved	19.Jun.2003	T.Ishii	Taping and Reel Spec		ec.	-00101	D		

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NOTE

1. Frequency Code

Marking Frequency is consist of five digits, first five digits of Nominal Frequency

Example

Nominal Frequency	28.636363 MHz		
Frequency Code	28.636		

2. Month Code Table

Month	1	2	3	4	5	6	7	8	9	10	11	12
	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Month Code	1	2	3	4	5	6	7	8	9	х	Y	Z

*Marking digits are not include a decimal point and dot mark.

	Dat	e of Revise	Charge	Approved	Approved Reason			
В	10	.July.2008	Miyahara	K.Kubota	K.Kubota Delete application period.			
		Date	Name	Third Angle Projection Toler		Tolerance		ale
Draw	vn	16.Jan.2006	I.Miyahara	Dimension:mm				/
Des	igned	16.Jan.2006	I.Miyahara	Title		Drawing No.		Rev.
Che	cked	16.Jan.2006				EVIIAAD	00247	
Арр	roved	16.Jan.2006	K.Okamoto	Crystal Holder Marking		EXH11B-	-00317	В

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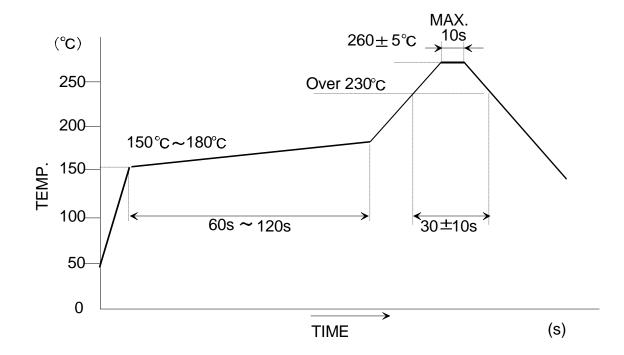
			(page: 1/1)
No.	Test Item	Test Methods	Specification Code
1	High Temperature Storage *1	+85±3°C 720h	А
2	Low Temperature Storage	-40±3°C 500h	А
3	Temperature Humidity	+60±3°C 90~95%RH 500h	А
4	Temperature Cycling *1	-40±3°C / +85±3°C It is 500 cycles using 30 minutes each as 1 cycle.	А
5	Vibration	Frequency Range : 10~55Hz Amplitude : 1.52mm 1 cycle : 1 minutes Test time : Three mutually perpendicular axes each 2 hours.	A
6	Shock	Devices are shocked to half sine wave (981m/s ²) three mutually perpendicular axis each 3 times.	А
7	Drop	Devices are dropped from the height 75cm onto wooden block. (more than 30mm thickness.) Execution 3 times random drops	A
8	Solderability	Pre-heat temperature : +150±10°C Pre-heat time : 60~120s When the temperature of the specimen is reached at +215±3°C, it shall be left for 30±1sec. Peak temperature 240±5°C Material: Pb-free (Sn-3.0Ag-0.5Cu) Flux : Rosin resin methyl alcohol solvent (1:4)	В
9	Reflow resistance	Pre-heat temperature : +150~180°C Pre-heat time : 90±30s Heat temperature : more than +230°C Heat time : 30s±10s Peak temperature : +260±5°C Peak time : less than 10s	A

Reliability assurance item

*1. High Temperature Storage and Temperature Cycling In case of customer spec on High temperature exceed +85°C, Low temperature exceed -40°C, above test according to customer spec high or low temperature will be perform and guarantee.

Specification code	Specification
А	$\Delta f/f \le \pm 5 \text{ ppm}$ $\Delta CI/CI \le \pm 15 \% \text{ or } 5 \Omega \text{ make use larger value}$
В	The electrodes should be covered by a new solder at least 90% of immersed area.





1.IR reflow condition